

QUICKSWITCH[®] PRODUCTS HIGH-SPEED CMOS QUICKSWITCH 16-BIT LOW RESISTANCE MULTIWIDTH[™] BUS SWITCH

IDTQS32XR245

FEATURES:

- · Enhanced N channel FET with no inherent diode to Vcc
- 2.5Ω bidirectional switches connect inputs to outputs
- Zero propagation delay, zero ground bounce
- QS32XR245 is a 16-bit version of QS3R245
- · Flow-through pinout for easy layout
- · Undershoot clamp diodes on all switch and control inputs
- TTL-compatible control inputs
- · Available in 40-pin QVSOP package

APPLICATIONS:

- · Low resistance applications
- Hot-swapping, hot-docking (low resistance for PCI and Compact PCI applications)

FUNCTIONAL BLOCK DIAGRAM

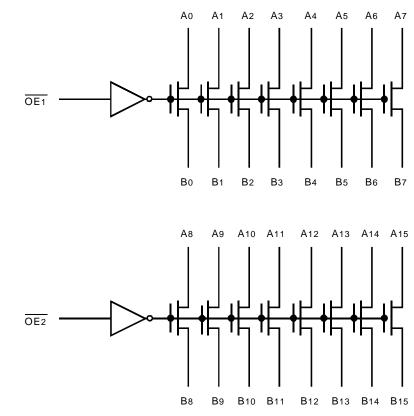
- Voltage translation (5V to 3.3V)
- Capacitance reduction and isolation
- Power conservation
- · Logic replacement (data processing)
- Clock gating

DESCRIPTION:

The QS32XR245 is a member of the MultiWidthTM family of QuickSwitch devices and provides a set of 32 high-speed low resistance CMOS compatible bus switches in a flow-thru pinout. This device is available in the MillipaQ package, the world's first small outline 16-bit solution. The low on-resistance of the QS32XR245 allows inputs to be connected to outputs without adding propagation delay and without generating additional ground bounce noise. When Output Enable (\overline{OEn}) is low, the switches are turned on, connecting bus A to bus B. When \overline{OEn} is high, the switches are turned off. This device is ideally suited for 16/32 bit applications where board space is at a premium. The low resistance of QS32XR245 makes it ideal for PCI hot docking application.

QuickSwitch devices provide an order of magnitude faster speed than conventional logic devices.

The QS32XR245 is characterized for operation at -40°C to +85°C.



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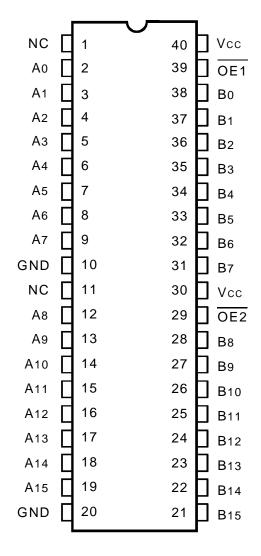
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INDUSTRIAL TEMPERATURE RANGE

NOVEMBER 1999

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PINCONFIGURATION



QVSOP TOP VIEW

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Description	Max	Unit
VTERM ⁽²⁾	Supply Voltage to Ground	-0.5 to +7	V
VTERM ⁽³⁾	DC Switch Voltage Vs	-0.5 to +7	V
VTERM ⁽³⁾	DC Input Voltage VIN	-0.5 to +7	V
VAC	AC Input Voltage (pulse width \leq 20ns)	-3	V
Ιουτ	DC Output Current	120	mA
Рмах	Maximum Power Dissipation (TA = 85°C)	0.92	W
Tstg	Storage Temperature	-65 to +150	°C

NOTE:

 Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

2. Vcc terminals.

3. All terminals except Vcc.

CAPACITANCE

 $(TA = +25^{\circ}C, f = 1.0MHz, VIN = 0V, VOUT = 0V)$

Pins	Тур.	Max. ⁽¹⁾	Unit
Control Pins	3	4	pF
Quickswitch Channels (Switch OFF)	5	6	pF

NOTE:

1. This parameter is measured at characterization but not tested.

PINDESCRIPTION

Pin Names I/O		Description
OE1, OE2	I	Output Enable
An	I/O	Bus A
Bn	I/O	Bus B

FUNCTION TABLE⁽¹⁾

OE1	OE2	A0 - A7	A8 - A15	Function
Н	Н	Z	Z	Disconnect
L	Н	B0 - B7	Z	Connect
Н	L	Z	B8 - B15	Connect
L	L	B0 - B7	B8 - B15	Connect

NOTE:

1. H = HIGH Voltage Level

L = LOW Voltage Level

Z = High-Impedance

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

 ${\sf Following\,Conditions\,Apply\,Unless\,Otherwise\,Specified:}$

Industrial: TA = -40° C to $+85^{\circ}$ C, VCC = $5.0V \pm 10\%$

Symbol	Parameter	Test Conditions	Min.	Typ. ⁽¹⁾	Max.	Unit
Vih	Input HIGH Level	Guaranteed Logic HIGH for Control Pins	2	_	_	V
Vil	Input LOW Level	Guaranteed Logic LOW for Control Pins	_	—	0.8	V
lin	Input LeakageCurrent (Control Inputs)	$0V \le VIN \le VCC$	_	—	±1	μA
loz	Off-State Output Current (Hi-Z)	$0V \le VOUT \le Vcc$, Switches OFF	_	_	±1	μA
Ron	Switch ON Resistance ⁽²⁾	VCC = Min., VIN = 0V, ION = 30mA	_	2.5	5	Ω
		VCC = Min., VIN = 2.4V, ION =15mA	_	4	8.5	
Vp	Pass Voltage ⁽³⁾	$V_{IN} = V_{CC} = 5V$, $I_{OUT} = -5\mu A$	3.7	4	4.3	V

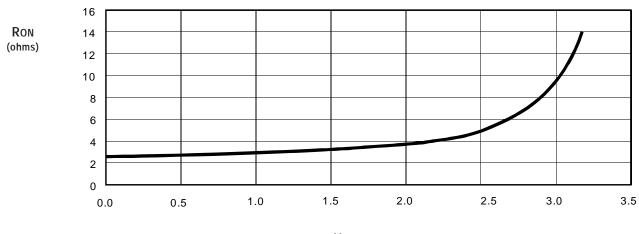
NOTES:

1. Typical values are at Vcc = 5.0V, TA = 25°C.

2. Max value of Ron is guaranteed but not production tested.

3. Pass Voltage is guaranteed but not production tested.

TYPICAL ON RESISTANCE vs VIN AT Vcc = 5V



VIN (Volts)

POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Conditions ⁽¹⁾ Max.		Unit
lcco	Quiescent Power Supply Current	Vcc = Max., VIN = GND or Vcc, f = 0	6	μΑ
Δlcc	Power Supply Current per Control Input HIGH ⁽²⁾	Vcc = Max., VIN = 3.4V, f = 0	2.5	mA
ICCD	Dynamic Power Supply Current per MHz ⁽³⁾	Vcc = Max., A and B pins open Control Inputs Toggling at 50% Duty Cycle	0.25	mA/MHz

NOTES:

1. For conditions shown as Min. or Max., use the appropriate values specified under DC Electrical Characteristics.

2. Per TLL driven input (VIN = 3.4V, control inputs only). A and B pins do not contribute to Δ Icc.

3. This current applies to the control inputs only and represents the current required to switch internal capacitance at the specified frequency. The A and B inputs generate no significant AC or DC currents as they transition. This parameter is guaranteed but not production tested.

SWITCHING CHARACTERISTICS OVER OPERATING RANGE

 $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$, $V_{CC} = 5.0V \pm 10\%$;

CLOAD = 50pF, $RLOAD = 500\Omega$ unless otherwise noted.

Symbol	Parameter	Min. ⁽¹⁾	Тур.	Max.	Unit
t PLH	Data Propagation Delay ^(2,3)	—	—	0.12	ns
t PHL	An to/from Bn				
tPZL	Switch Turn-on Delay	0.5	—	5.6	ns
tрzн	OEn to An/Bn				
tPLZ	Switch Turn-off Delay ⁽²⁾	0.5	—	4.5	ns
tрнz	OEn to An/Bn				

NOTES:

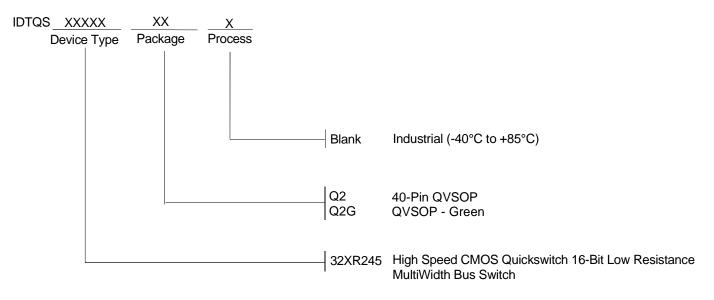
1. Minimums are guaranteed but not production tested.

2. This parameter is guaranteed but not production tested.

^{3.} The bus switch contributes no propagation delay other than the RC delay of the ON resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.12ns for C_L = 50pF. Since this time constant is much smaller than the rise and fall times of typical driving signals, it adds very little propagation delay to the system. Propagation delay of the bus switch, when used in a system, is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

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ORDERING INFORMATION





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